TMN6003MI

N-Channel Enhancement Mosfet

General Description

- Low $R_{DS(ON)}$
- RoHS and Halogen-Free Compliant

Applications

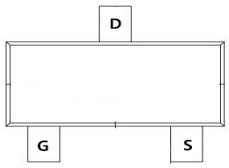
- Load switch
- PWM

General Features

V_{DS} =60V I_D =3.0A

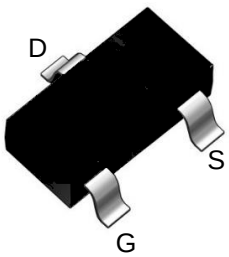
$R_{DS(ON)}$ = 75 mΩ(Typ.) @ V_{GS}=10V

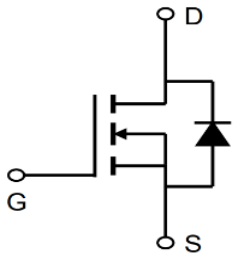
100% UIS Tested
100% R_g Tested



Marking:ARDP OR 2310D

MI:SOT-23-3L





Absolute Maximum Ratings: (T_a=25℃ unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	60	V
V_{GS}	Gate-Source Voltage	±20	V
I_D	Continuous Drain Current-T_A=25℃	3.0	A
	Continuous Drain Current-T_A=100℃	2.2	
I_{DM}	Pulse Drain Current Tested note1	14	A
P_D	Power Dissipation-T_A=25℃	1.7	W
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	℃

Thermal Characteristics:

Symbol	Parameter	Max	Units
$R_{\Theta JA}$	Thermal Resistance,Junction to Ambient	73.5	℃/W

Electrical Characteristics: (T_C=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Sourtce Breakdown Voltage	V_{GS}=0V,I_D=250μA	60	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{GS}=0V, V_{DS}=60V	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	V_{GS}=±20V, V_{DS}=0A	---	---	±100	nA
On Characteristics						
$V_{GS(th)}$	GATE-Source Threshold Voltage	V_{GS}=V_{DS}, I_D=250μA	1	1.5	2.5	V
$R_{DS(on)}$	Drain-Source on-Resistance note2	V_{GS}=10V,I_D=3A	---	75	105	mΩ
		V_{GS}=4.5V,I_D=2A	---	85	110	
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS}=25V, V_{GS}=0V, f=1MHz	---	325	---	pF
C_{oss}	Output Capacitance		---	85	---	
C_{rss}	Reverse Transfer Capacitance		---	15	---	
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DS}=30V, V_{GS}=10V, I_D=2A, R_{GEN}=3Ω	---	13	---	ns
t_r	Rise Time		---	51	---	ns
$t_{d(off)}$	Turn-Off Delay Time		---	19	---	ns
t_f	Fall Time		---	12	---	ns
Q_g	Total Gate Charge	V_{GS}=10V, V_{DS}=30V, I_D=3A	---	5.1	---	nC
Q_{gs}	Gate-Source Charge		---	1.3	---	nC
Q_{gd}	Gate-Drain “Miller” Charge		---	1.7	---	nC
Drain-Source Diode Characteristics						
I_S	Continuous Source Current	---	---	---	3	A
I_{SM}	Pulsed Source Current	---	---	---	12	A
V_{SD}	Forward Voltage	V_{GS}=0V , I_S=3A	---	---	1.2	V

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
2. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%

Typical Characteristics: (T_C=25℃ unless otherwise noted)

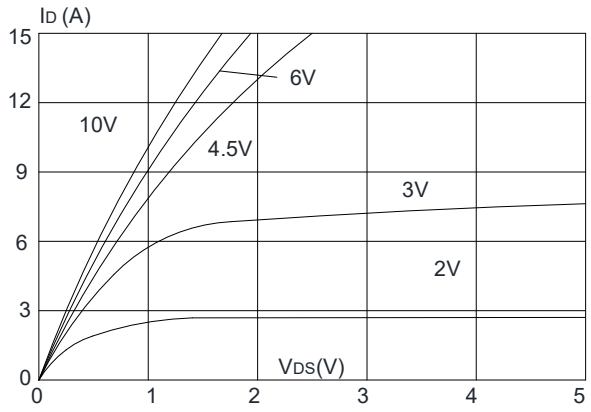


Figure1: Output Characteristics

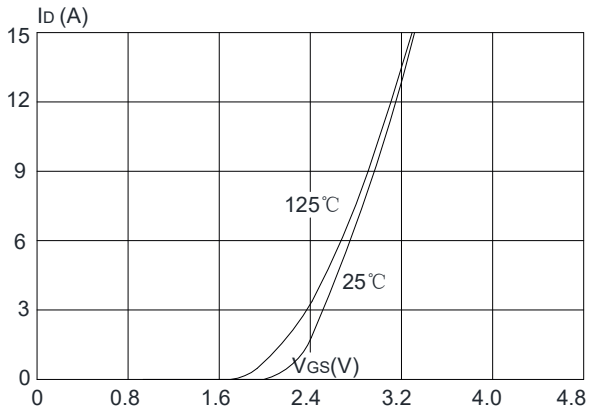


Figure 2: Typical Transfer Characteristics

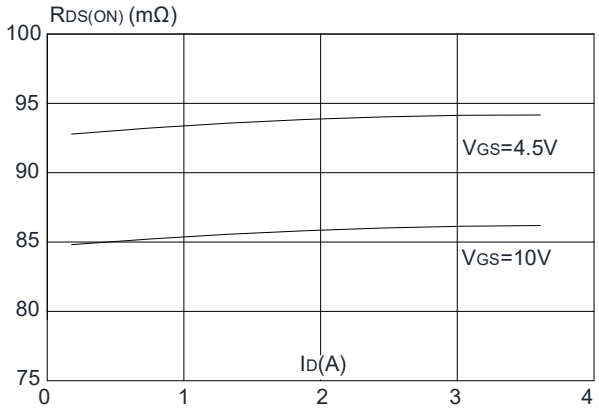


Figure 3: On-resistance vs. Drain Current

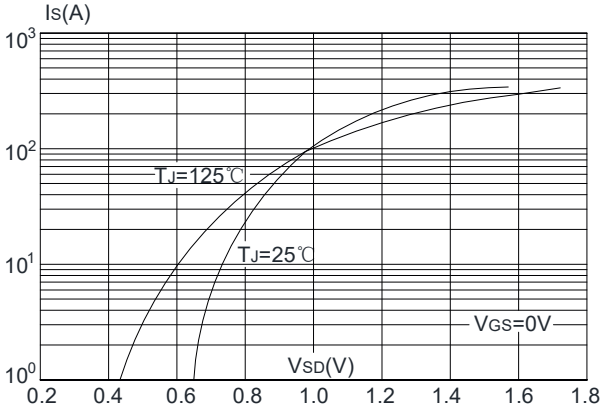


Figure 4: Body Diode Characteristics

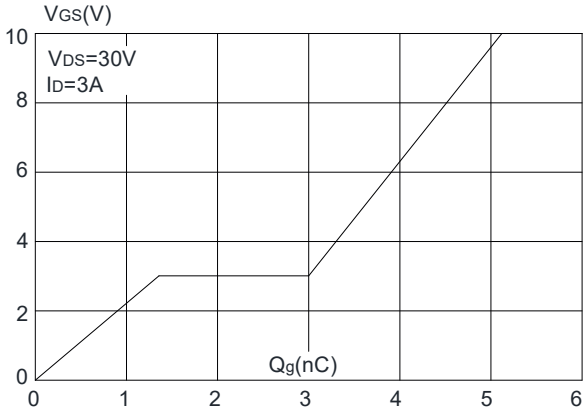


Figure 5: Gate Charge Characteristics

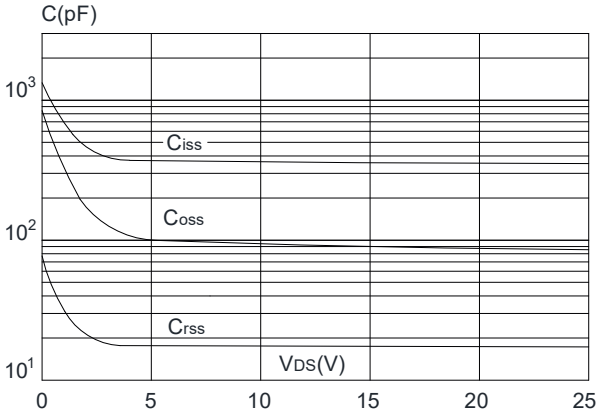


Figure 6: Capacitance Characteristics

Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

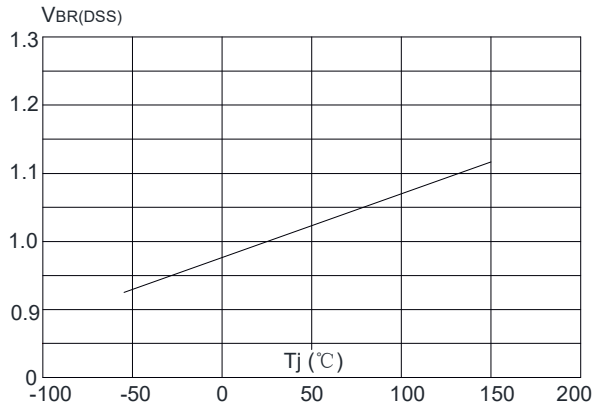


Figure 8: Normalized on Resistance vs. Junction Temperature

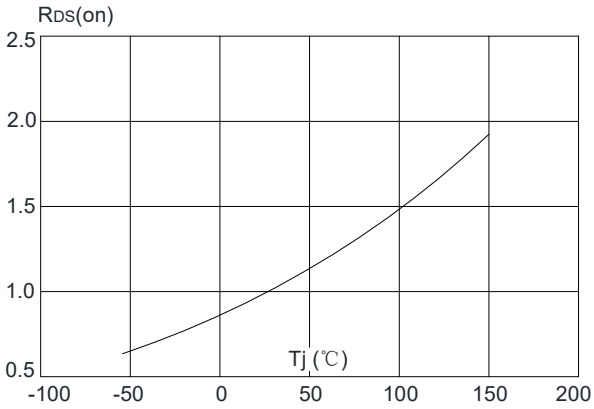


Figure 9: Maximum Safe Operating Area

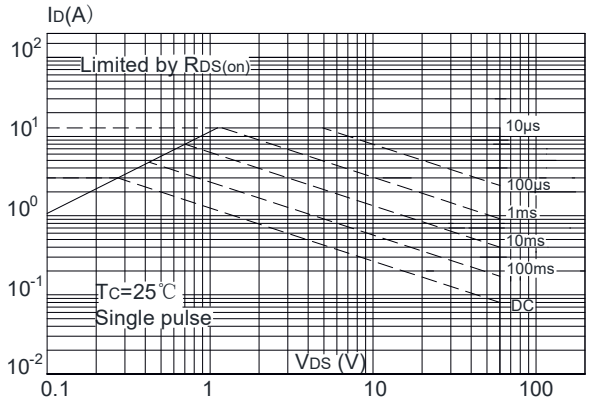


Figure 10: Maximum Continuous Drain Current vs. Case Temperature

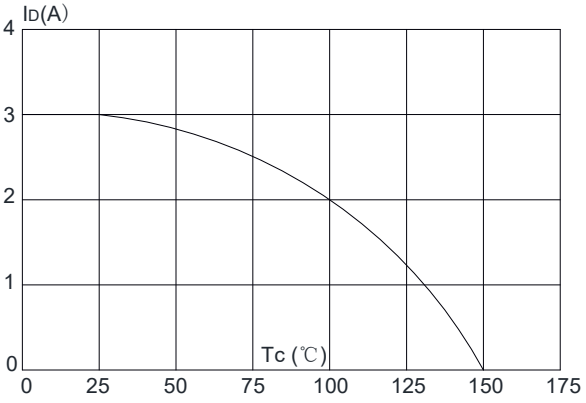
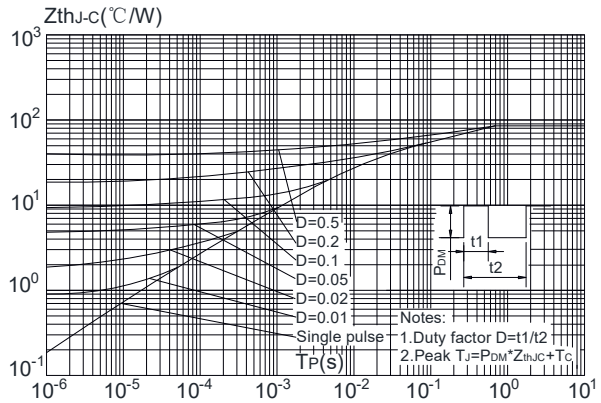


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case



Package Information:SOT-23-3L

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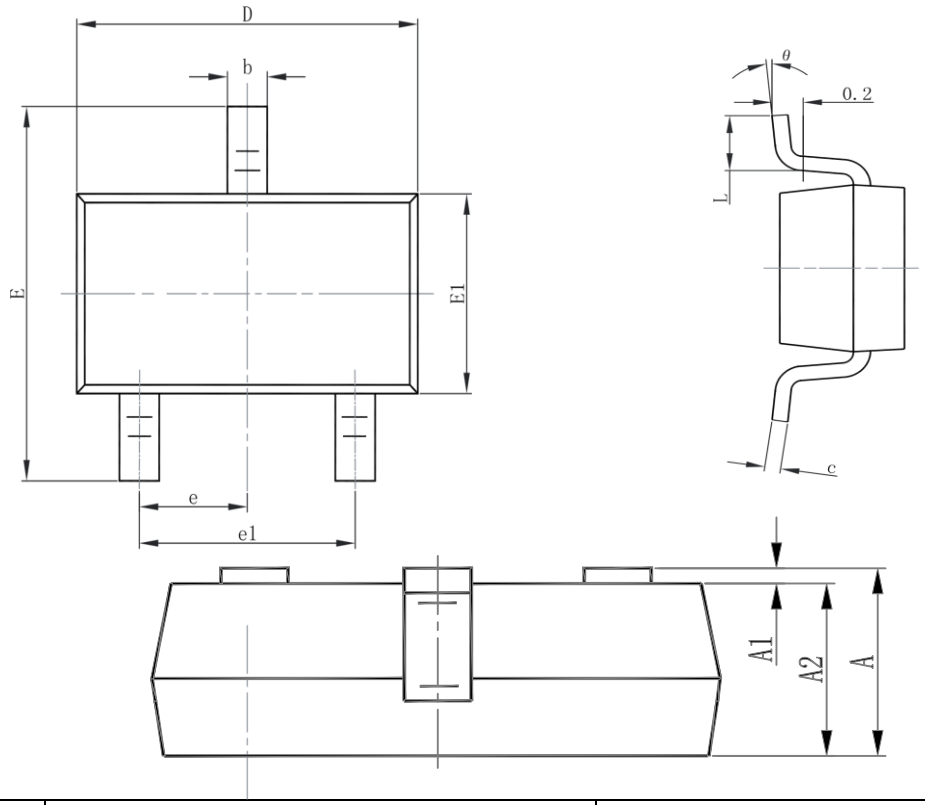

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	1.500	1.700	0.059	0.067
E	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°